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ATTORNEY DOCKET NO. 43876-48

[6605-9]

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Paul Poenisch et al.

Serial No.: (08/478,114

Filed: June 7, 1995

For: LOW COST, HIGH PERFORMANCE

FLIP-CHIP BONDING TECHNIQUE )

Group Art Unit: 1107

Examiner: D. E. GRAYBILL

RECEIVED

DEC 1.2

LETTER SUBMITTING FORMAL DRAWINGS AFTER NOTICE OF ALLOWANCE

Honorable Assistant Commissioner for Patents

ATTN: OFFICIAL DRAFTSMAN Washington, D.C. 20231

Sir:

Applicants submit four (4) sheets of formal drawings, consisting of Figures 1-6, in the above-captioned patent application. If there are any questions concerning the drawings, please contact the undersigned representative at the telephone number listed below.

Please grant any extension of time that is necessary for entry of this communication. Please charge any deficient fees, or credit any overpayment of fees, to Deposit Account No. 13-0203. A duplicate copy of this communication is attached.

Respectfully submitted, MCDERMOTT, WILL & EMERY

Dated: December 29, 1997 By:

Michael E. ogarty

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